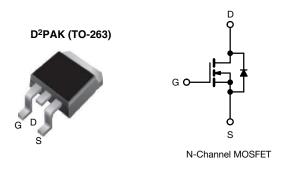


**Vishay Siliconix** 

# **EF Series Power MOSFET With Fast Body Diode**



PRODUCT SUMMARY						
$V_{DS}$ (V) at $T_J$ max.	650					
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	V <sub>GS</sub> = 10 V 0.084					
Q <sub>g</sub> max. (nC)	134					
Q <sub>gs</sub> (nC)	16					
Q <sub>gd</sub> (nC)	48					
Configuration	Single					

#### **FEATURES**

- A specific on resistance (m $\Omega$ -cm<sup>2</sup>) reduction of 25 %
- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>g</sub>)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

ORDERING INFORMATION				
Package	D <sup>2</sup> PAK (TO-263)			
Lead (Pb)-free and halogen-free	SiHB35N60EF-GE3			

PARAMETER	SYMBOL	LIMIT	UNIT			
Drain-source voltage	V <sub>DS</sub>	600	V			
Gate-source voltage	V <sub>GS</sub>	± 30	V			
Continuous drain current ( $T_{,1} = 150 \ ^{\circ}C$ )	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C		32		
Continuous drain current $(1) = 150^{\circ}$ C)	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C	ID	20	А	
Pulsed drain current <sup>a</sup>	I <sub>DM</sub>	80				
Linear derating factor		2.0	W/°C			
Single pulse avalanche energy <sup>b</sup>	E <sub>AS</sub>	298	mJ			
Maximum power dissipation	PD	250	W			
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C			
Drain-source voltage slope	oltage slope T <sub>J</sub> = 125 °C			100		
Reverse diode dv/dt d		dv/dt	50	V/ns		
Soldering recommendations (peak temperature) <sup>c</sup>	For	For 10 s		260	°C	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b.  $V_{DD}$  = 140 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>q</sub> = 25  $\Omega$ , I<sub>AS</sub> = 4.6 A

c. 1.6 mm from case

d.  $I_{SD}$  = 17 A, di/dt = 300 A/µs, starting T<sub>J</sub> = 25 °C

S20-0091-Rev. B, 17-Feb-2020

1



COMPLIANT HALOGEN

FREE



Vishay Siliconix

PARAMETER	SYMBOL TYP. MAX							
Maximum junction-to-ambient	R <sub>thJA</sub>	- 62						
Maximum junction-to-case (drain)	R <sub>thJC</sub>	- 0.5				°C/W		
<b>SPECIFICATIONS</b> ( $T_J = 25 \text{ °C}$ , u	Inless otherw	ise noted)						
PARAMETER	SYMBOL	TES	TEST CONDITIONS			TYP.	MAX.	UNIT
Static								
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 2	250 µA	600	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	I <sub>D</sub> = 10 mA	-	0.66	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 2	250 µA	2.0	-	4.0	V
	1	,	$V_{\rm GS} = \pm 20$	V	-	-	± 100	nA
Gate-source leakage	I <sub>GSS</sub>	,	$V_{\rm GS} = \pm 30$	V	-	-	± 1	μA
7		V <sub>DS</sub> =	480 V, V <sub>G</sub>	<sub>S</sub> = 0 V	-	-	1	μA
Zero gate voltage drain current	IDSS	V <sub>DS</sub> = 480 V	', V <sub>GS</sub> = 0 V	′, T <sub>J</sub> = 125 °C	-	-	500	
Drain-source on-state resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$			-	0.084	0.097	Ω
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 30 V, I <sub>D</sub> = 17 A		-	8	-	S	
Dynamic		•						
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz			-	2568	-	pF
Output capacitance	C <sub>oss</sub>				-	113	-	
Reverse transfer capacitance	C <sub>rss</sub>				-	7	-	
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	$V_{DS}$ = 0 V to 480 V, $V_{GS}$ = 0 V			-	81	-	
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>				-	421	-	
Total gate charge	Qg				-	89	134	
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V I <sub>D</sub> = 17 A, V <sub>DS</sub> = 480 V		-	16	-	nC	
Gate-drain charge	Q <sub>gd</sub>				-	48	-	1
Turn-on delay time	t <sub>d(on)</sub>				-	28	56	
Rise time	t <sub>r</sub>		: 480 V, I <sub>D</sub> :	= 17 A,	-	85	170	
Turn-off delay time	t <sub>d(off)</sub>		= 10 V, R <sub>g</sub> =		-	96	192	ns
Fall time	t <sub>f</sub>			-	61	122	1	
Gate input resistance	R <sub>g</sub>	f = 1	MHz, oper	n drain	0.2	0.5	1.0	Ω
Drain-Source Body Diode Characteristi								
Continuous source-drain diode current	۱ <sub>S</sub>	MOSFET sym showing the	MOSFET symbol		-	-	32	
Pulsed diode forward current	I <sub>SM</sub>	integral reverse p - n junction diode		-	-	80	A	
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 17 A, V <sub>GS</sub> = 0 V			-	-	1.2	V
Reverse recovery time	t <sub>rr</sub>				-	150	300	ns
Reverse recovery charge	Q <sub>rr</sub>	$T_{J} = 25$	5 °C, I <sub>F</sub> = I <sub>S</sub>	= 17 A,	-	1.1	2.2	μC
Reverse recovery current	I <sub>RRM</sub>	di/dt = 100 A/µs, V <sub>R</sub> = 400 V			-	14		μ0 A

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

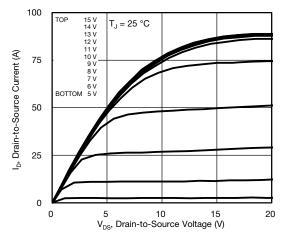


Fig. 1 - Typical Output Characteristics

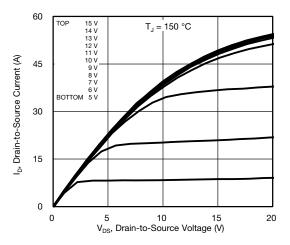


Fig. 2 - Typical Output Characteristics

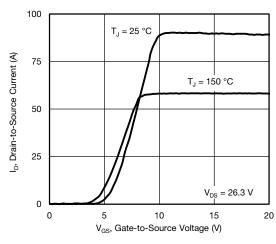


Fig. 3 - Typical Transfer Characteristics

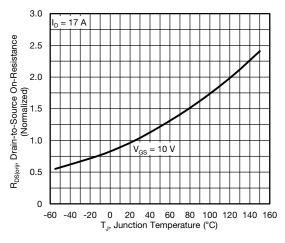


Fig. 4 - Normalized On-Resistance vs. Temperature

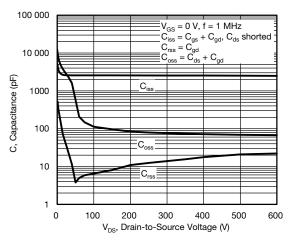


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

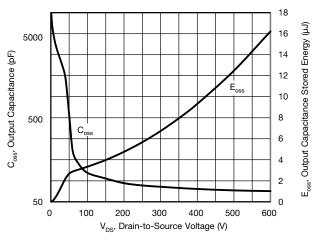


Fig. 6 -  $C_{oss}$  and  $E_{oss}$  vs.  $V_{DS}$ 

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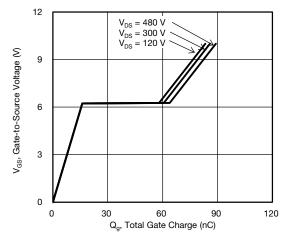


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

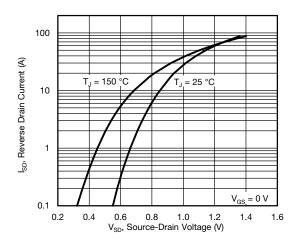
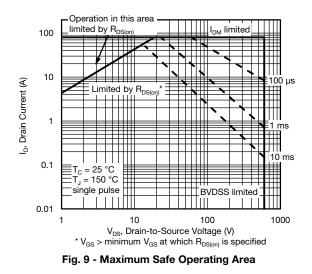


Fig. 8 - Typical Source-Drain Diode Forward Voltage



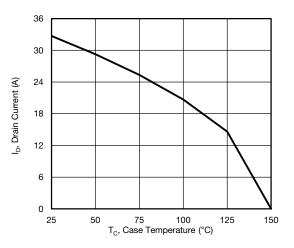


Fig. 10 - Maximum Drain Current vs. Case Temperature

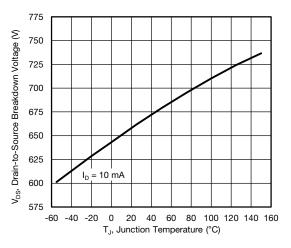
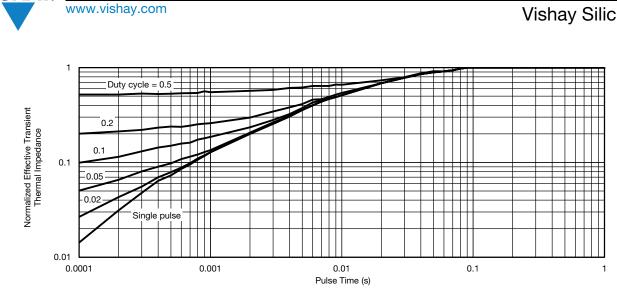
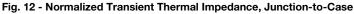


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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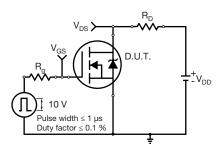


Fig. 13 - Switching Time Test Circuit

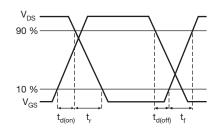


Fig. 14 - Switching Time Waveforms

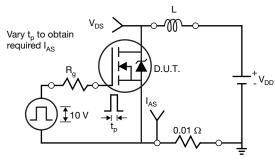


Fig. 15 - Unclamped Inductive Test Circuit

V<sub>DD</sub> V<sub>DS</sub> AS Fig. 16 - Unclamped Inductive Waveforms

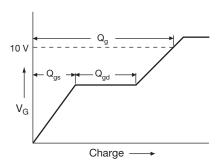


Fig. 17 - Basic Gate Charge Waveform

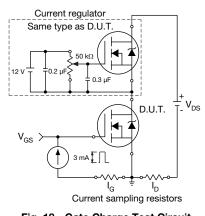


Fig. 18 - Gate Charge Test Circuit

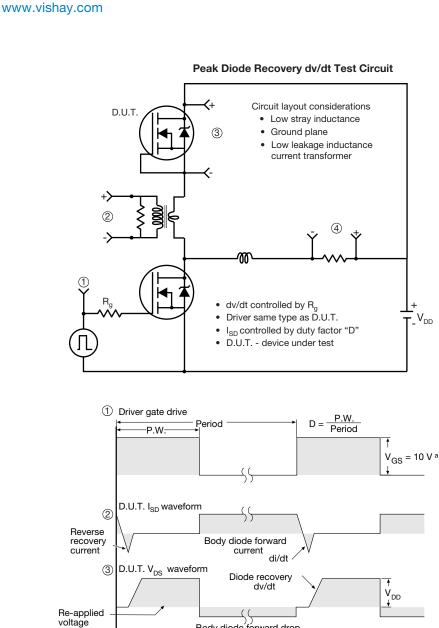
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SiHB35N60EF

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Body diode forward drop Inductor current 4 55 t  $I_{SD}$ Ripple ≤ 5 %

Note

a.  $V_{GS} = 5$  V for logic level devices

Fig. 19 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon

SiHB35N60EF

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V<sub>DD</sub>

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### **TO-263AB (HIGH VOLTAGE)**

/3

ВH B 4

A

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Detail A

(Datum A)

D

 $\underline{4}$ 11

Plating $(c)$ Lead tip $(c)$ (c)						• •	scale 8:1				
	MILLIMETERS		INC	INCHES			MILLIMETERS		INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.		DIM.	MIN.	MAX.	MIN.	MA	
А	4.06	4.83	0.160	0.190		D1	6.86	-	0.270	-	
A1	0.00	0.25	0.000	0.010		E	9.65	10.67	0.380	0.4	
b	0.51	0.99	0.020	0.039		E1	6.22	-	0.245	-	
b1	0.51	0.89	0.020	0.035		е	2.54 BSC		0.100	) BSC	
b2	1.14	1.78	0.045	0.070		Н	14.61	15.88	0.575	0.6	
b3	1.14	1.73	0.045	0.068		L	1.78	2.79	0.070	0.1	
С	0.38	0.74	0.015	0.029		L1	-	1.65	-	0.0	
c1	0.38	0.58	0.015	0.023		L2	-	1.78	-	0.0	
c2	1.14	1.65	0.045	0.065		L3	0.25 BSC		0.010 BSC		

Α

ECN: S-82110-Rev. A, 15-Sep-08 DWG: 5970

8.38

Notes

D

9.65

0.330

0.380

2. Dimensions are shown in millimeters (inches).

3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.

L4

5.28

0.188

4.78

4. Thermal PAD contour optional within dimension E, L1, D1 and E1.

- 5. Dimension b1 and c1 apply to base metal only.
- 6. Datum A and B to be determined at datum plane H.
- 7. Outline conforms to JEDEC outline to TO-263AB.



H

A1

B

Gauge plane 0° tọ 8°

L3

Detail "A" Rotated 90° CW

coolo 9.1

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Seating plane

MAX.

0.420

-

0.625

0.110 0.066

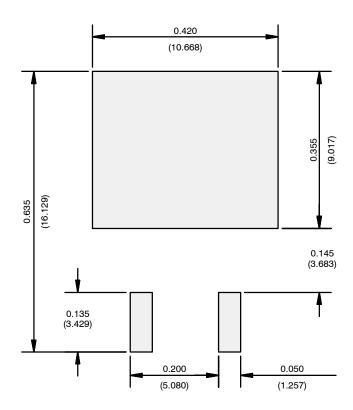
0.070

0.208

<sup>1.</sup> Dimensioning and tolerancing per ASME Y14.5M-1994.



### **RECOMMENDED MINIMUM PADS FOR D<sup>2</sup>PAK: 3-Lead**



Recommended Minimum Pads Dimensions in Inches/(mm)

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